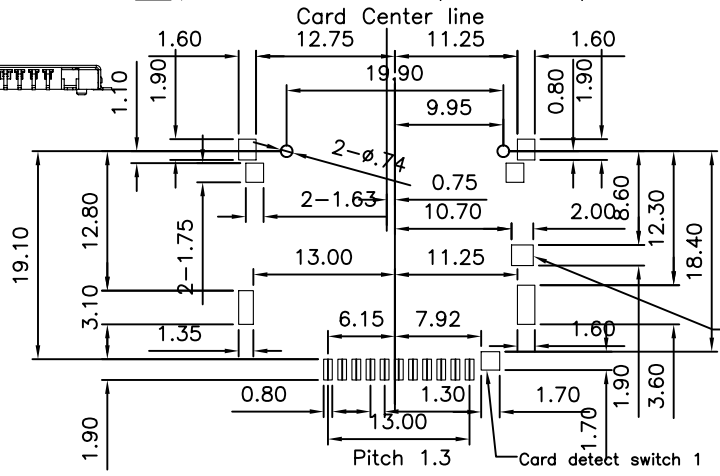
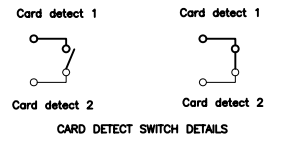


重點:該尺寸需以Mini-SD卡片金手指
最小厚度1.1金手指
之卡片做接觸導通測試



PIN1	CD/DAT3
PIN2	CMD
PIN3	VSS1
PIN4	VDD
PIN5	CLK
PIN6	VSS2
PIN7	DAT0
PIN8	DAT1
PIN9	DAT2
PIN10	NC(FOR FUTURE USE)
PIN11	NC(FOR FUTURE USE)
PIN12	Card detect 1
PIN13	Card detect 2



RECOMMENDED P.C.B LAYOUT
TOLERANCES:±0.05mm

SPECIFICATION

MATERIAL
 Insulator: Thermal Plastic UL94V-0
 Contacts: Copper Alloy
 Shell: Stainless Steel
CONTACT PLATING
 Underplate: 50u"~100u" Nickel
 Contact Area: 3u" and 15u" Selective Gold
 Solder Tails Area: 100u"~200u" Tin/Lead(Brighten Tin) or
 100u"~200u" Tin/Lead Free(Brighten Tin/Matte Tin)

ELECTRICAL
 Operation Voltage: 3.3
 Current Rating: 0.5 Amps Max.
 Contact Resistance: 100 mΩ At 1mA/20mV Max.
 Insulation Resistance: 1000 MΩ

